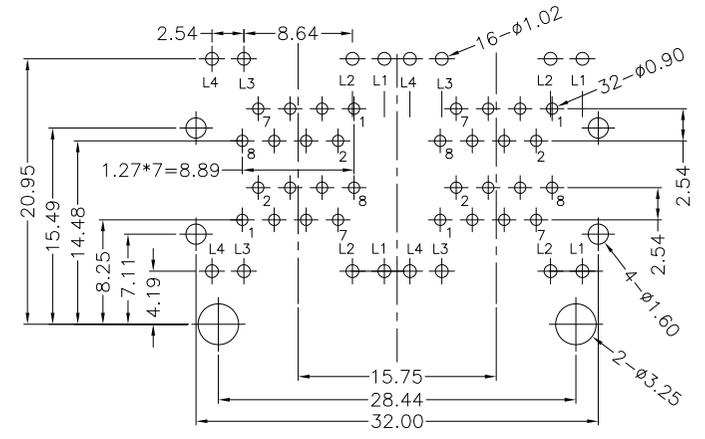
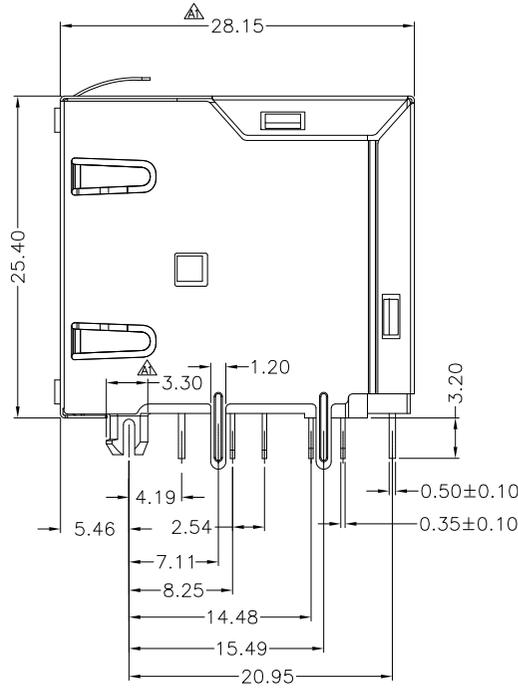
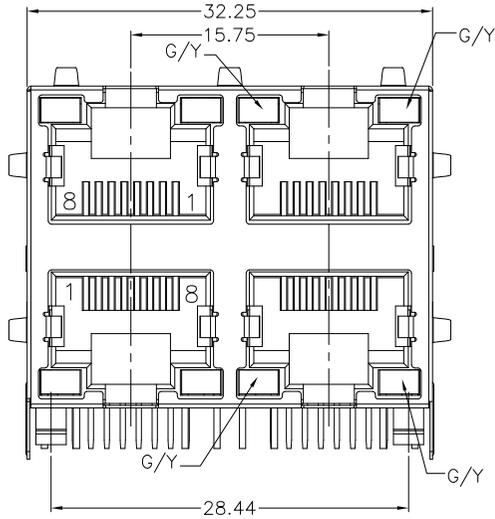


# GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2018/10/03	Phebe Su
A1			Change DIM.	2021/04/13	Hanson

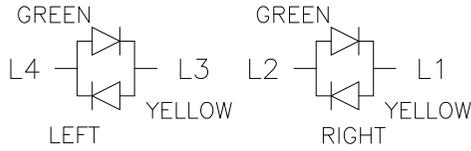
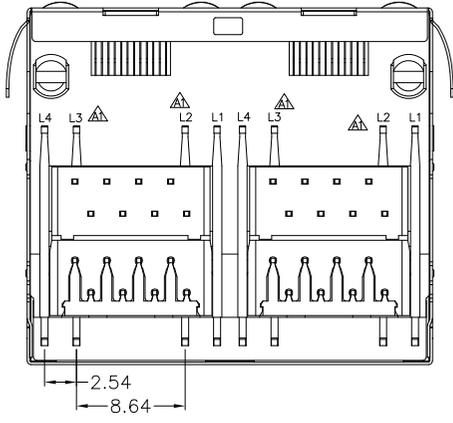
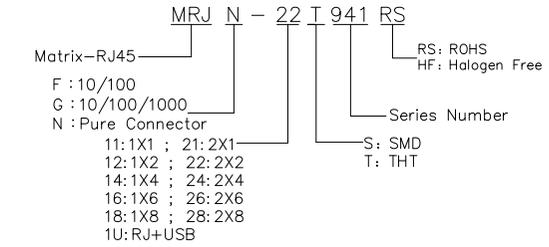


RECOMMENDED PCB LAYOUT(TOP SIDE)  
TOLERANCE ±0.05

NOTES:

- MATERIAL:  
HOUSING:PA46,UL94V-0,BLACK  
CONTACT:PHOSPHOR BORNZE,T=0.35, GOLD 3u" ON CONTACT AREA,  
MATTE TIN ON SOLDER TAIL.  
SHELL:COPPER ALLOY, NICKEL 30u" OVERALL
- OPERATING TEMPERATURE: -40°C ~ +85°C
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS  
PART 68, SUBPART F

ORDER INFORMATION:



Matrix Electronics Co.,Ltd				
TOLERANCE: X.X X.XX ±0.38 X.XXX ±0.25 X.XXX ±0.13 X.* ±2° X.X* ±1°	DESIGN BY : Hanson Huang	DATE : 2021/04/13	PART NAME: RJ45 2X2 CONN,W/LED	
UNIT: mm [inch] SCALE:1:1 SIZE:A4	CHECKED BY: Janice Liu	DATE : 2021/04/13	PART NO.	MRJN-22T941RS
	APPROVED BY1: Richard Hsieh	DATE : 2021/04/13	MOLD NO.	NA
	APPROVED BY2: Richard Hsieh	DATE : 2021/04/13	DRAW NO.	
			SHEET NO.	1 OF 1